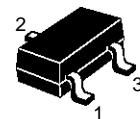


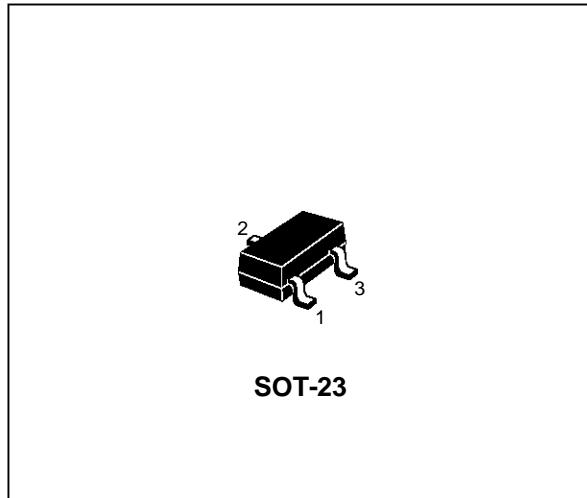
SMALL SIGNAL PNP TRANSISTOR

Type	Marking
BCX17	T1

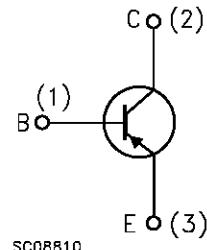
- SILICON EPITAXIAL PLANAR PNP TRANSISTORS
- MINIATURE PLASTIC PACKAGE FOR APPLICATION IN SURFACE MOUNTING CIRCUITS
- MEDIUM CURRENT AF AMPLIFICATION AND SWITCHING
- NPN COMPLEMENTS IS BCX19



SOT-23



INTERNAL SCHEMATIC DIAGRAM



SC08810

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V_{CES}	Collector-Emitter Voltage ($I_{BE} = 0$)	-50	V
V_{CEO}	Collector-Emitter Voltage ($I_B = 0$)	-45	V
V_{EBO}	Emitter-Base Voltage ($I_C = 0$)	-5	V
I_C	Collector Current	-0.5	A
I_{CM}	Collector Peak Current	-1	A
I_B	Base Current	-0.1	A
I_{BM}	Base Peak Current	-0.2	A
I_{EM}	Emitter Peak Current	1	A
P_{tot}	Total Dissipation at $T_c = 25^\circ\text{C}$	350	mW
T_{stg}	Storage Temperature	-65 to 150	$^\circ\text{C}$
T_j	Max. Operating Junction Temperature	150	$^\circ\text{C}$

BCX17

THERMAL DATA

$R_{thj\text{-amb}}$ •	Thermal Resistance Junction-Ambient	Max	350	$^{\circ}\text{C/W}$
$R_{thj\text{-SR}}$ •	Thermal Resistance Junction-Substrate	Max	290	$^{\circ}\text{C/W}$

• Mounted on a ceramic substrate area = 15 x 15 x 0.6 mm

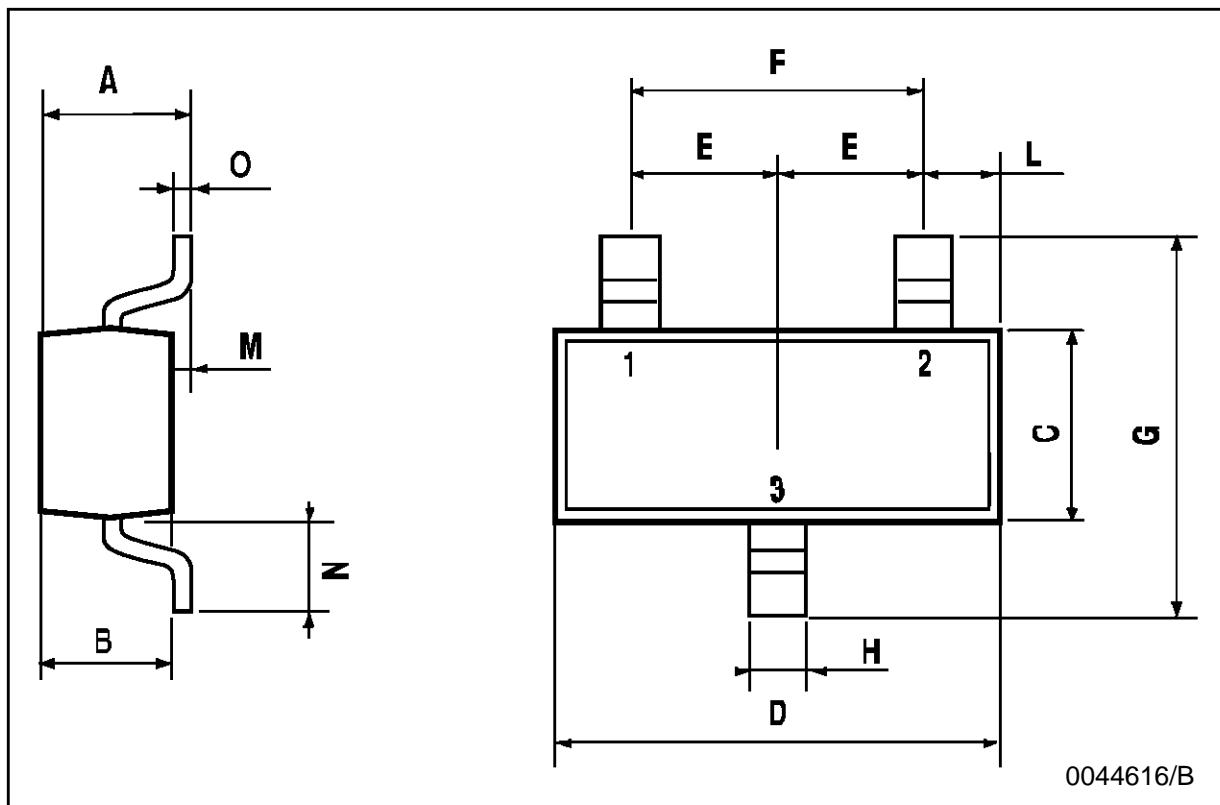
ELECTRICAL CHARACTERISTICS ($T_{\text{case}} = 25 \text{ }^{\circ}\text{C}$ unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
I_{CBO}	Collector Cut-off Current ($I_E = 0$)	$V_{CB} = -20 \text{ V}$ $V_{CB} = -20 \text{ V} \quad T_j = 150 \text{ }^{\circ}\text{C}$			-100 -5	nA μA
$V_{(\text{BR})\text{CES}}^*$	Collector-Emitter Breakdown Voltage ($V_{BE} = 0$)	$I_C = -10 \mu\text{A}$	-50			V
$V_{(\text{BR})\text{CEO}}^*$	Collector-Emitter Breakdown Voltage ($I_B = 0$)	$I_C = -10 \text{ mA}$	-45			V
$V_{(\text{BR})\text{EBO}}$	Emitter-Base Breakdown Voltage ($I_C = 0$)	$I_E = -10 \mu\text{A}$	-5			V
$V_{CE(\text{sat})}^*$	Collector-Emitter Saturation Voltage	$I_C = -500 \text{ mA} \quad I_B = -50 \text{ mA}$			-0.62	V
$V_{BE(\text{on})}^*$	Base-Emitter On Voltage	$I_C = -500 \text{ mA} \quad V_{CE} = -1 \text{ V}$			-1.2	V
h_{FE}^*	DC Current Gain	$I_C = -100 \text{ mA} \quad V_{CE} = -1 \text{ V}$ $I_C = -300 \text{ mA} \quad V_{CE} = -1 \text{ V}$ $I_C = -500 \text{ mA} \quad V_{CE} = -1 \text{ V}$	100 70 40			
f_T	Transition Frequency	$I_C = -10 \text{ mA} \quad V_{CE} = -5 \text{ V} \quad f = 100 \text{ MHz}$		100		MHz
C_{CB}	Collector Base Capacitance	$I_E = 0 \text{ mA} \quad V_{CB} = -10 \text{ V} \quad f = 1 \text{ MHz}$		8		pF

* Pulsed: Pulse duration = 300 μs , duty cycle $\leq 2 \%$

SOT-23 MECHANICAL DATA					
-------------------------------	--	--	--	--	--

DIM.	mm			mils		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	0.85		1.1	33.4		43.3
B	0.65		0.95	25.6		37.4
C	1.20		1.4	47.2		55.1
D	2.80		3	110.2		118
E	0.95		1.05	37.4		41.3
F	1.9		2.05	74.8		80.7
G	2.1		2.5	82.6		98.4
H	0.38		0.48	14.9		18.8
L	0.3		0.6	11.8		23.6
M	0		0.1	0		3.9
N	0.3		0.65	11.8		25.6
O	0.09		0.17	3.5		6.7



0044616/B

Information furnished is believed to be accurate and reliable. However, SGS-THOMSON Microelectronics assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of SGS-THOMSON Microelectronics. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information previously supplied. SGS-THOMSON Microelectronics products are not authorized for use as critical components in life support devices or systems without express written approval of SGS-THOMSON Microelectronics.

© 1995 SGS-THOMSON Microelectronics - Printed in Italy - All Rights Reserved

SGS-THOMSON Microelectronics GROUP OF COMPANIES

Australia - Brazil - Canada - China - France - Germany - Hong Kong - Italy - Japan - Korea - Malaysia - Malta - Morocco - The Netherlands -
Singapore - Spain - Sweden - Switzerland - Taiwan - Thailand - United Kingdom - U.S.A